FORM PTO-1594 (Modified) 1-31-92

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

	TRADEMARKS ONLY Attorney Docket No.: 57818-0016
To the Honorable Commissioner of Patent and Trademarks:	Please record the attached original documents or copy thereof.
Name of conveying party(ies):  Elgar Electronics Corporation (a California corporation)  3. Nature of conveyance:  [ ] Assignment [ ] Merger	2. Name and address of receiving party(ies):  Capitalsource Finance LLC (a Delaware limited liability company)  Address: 4445 Willard Avenue, 12th Floor Chevy Chase, MD 20815
[X] Security Agreement [ ] Change of Name [ ] Other:  Execution Date: March 8, 2004	[ ] Individual(s) citizenship: [ ] Association: [ ] General Partnership: [ ] Limited Partnership: [ ] Corporation-State: [ [X] Other: a Delaware limited liability company  If assignee is not domiciled in the U.S.A., a domestic representative designation is attached: [ ] Yes; [X] No [ (Designations must be a separate document from Assignment)
Application number(s) or registration number(s):     A. Trademark Application No.(s):	B. Trademark Registration Nos.: 2,781,232 2,548,827 2,796,705 2,548,823 2,624,856 2,548,824 2,624,857 2,551,585 2,548,822 2,596,187 2,684,819 972,782 2,788,297 2,713,410 2,203,753
<ol> <li>Name and address of party to whom correspondence document should be mailed:</li> <li>Cathleen F. Baraloto Senior Paralegal</li> </ol>	6. Total number of applications and registrations involved: 15
ATTN.: TMSU Morgan, Lewis & Bockius LLP 1111 Pennsylvania Avenue, NW	Total \$ 390.00  [X] Authorized to be charged to deposit account
Washington, D.C. 20004  Telephone: 202-739-5399  Facsimile: 202-739-3001  E-mail: cbaraloto@morganlewis.com	8. Deposit account number: 13-4520
DO	O NOT USE THIS SPACE
9. Statement and signature  To the best of my knowledge and belief, the foregoing in of the original document.  Cathleen F. Baraloto  Name of Person Signing	April 9, 2004 Signature  Total number of pages including cover sheet, attachments and document: 10
OMB No. 0651-0011 (exp. 4/94)	

<sup>1-WA/</sup>**700077680** 

# ACKNOWLEDGEMENT OF INTELLECTUAL PROPERTY COLLATERAL LIEN

This Acknowledgement of Intellectual Property Collateral Lien (this "Acknowledgement") is dated as of March 8, 2004, by ELGAR ELECTRONICS CORPORATION, a California corporation (the "Grantor"), in favor of CapitalSource Finance LLC, a Delaware limited liability company, as administrative, payment and collateral agent for the Lenders under the Loan Agreement described below (in such capacities, "Secured Party").

#### WITNESSETH:

WHEREAS, pursuant to that certain Revolving Credit, Term Loan and Security Agreement dated as of the date hereof among Elgar Holdings, Inc., the Grantor, Secured Party and the Lenders (as the same exists and may be amended, restated, supplemented, extended, renewed, replaced or otherwise modified from time to time, the "Loan Agreement"), the Lenders have agreed to provide Loans to the Grantor upon the terms and subject to the conditions set forth therein;

WHEREAS, the Grantor granted to Secured Party, for itself and the benefit of the Lenders, certain liens on the Collateral to secure its Obligations under the Loan Agreement; and

WHEREAS, pursuant to the terms of the Loan Agreement the Grantor is required to execute and deliver this Acknowledgment in favor of Secured Party, for itself and the benefit of the Lenders;

NOW, THEREFORE, in consideration of the premises and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, and to induce Secured Party and Lenders to enter into the Loan Documents and to make Loans to the Grantor thereunder, the Grantor hereby agrees with Secured Party as follows:

Section 1. <u>Defined Terms</u>. Capitalized terms used herein and not otherwise defined shall have the meanings assigned to such terms in the Loan Agreement or, to the extent the same are used or defined therein, the meanings provided in Article 9 of the UCC in effect from time to time. Whenever the context so requires, each reference to gender includes the masculine and feminine, the singular number includes the plural and vice versa. This Acknowledgement shall mean such agreement as the same now exists or may hereafter be amended, modified, supplemented, extended, renewed, restated or replaced, from time to time. References in this Acknowledgement to any Person shall include such Person and its successors and permitted assigns.

Section 2. Reaffirmation of Grant of Security Interest in Intellectual Property Collateral. The Grantor, as collateral security for the full, prompt and complete payment and performance when due (whether at stated maturity, by acceleration or otherwise) of the Obligations of the Grantor, hereby reaffirms its grant to Secured Party, for itself and the benefit of the Lenders, of a first priority security interest in the Intellectual Property Collateral (as defined below), and further reaffirms its collateral assignment, conveyance, mortgage, pledge, hypothecation and transfer to Secured Party, for itself and the benefit of the Lenders, and its

grant to Secured Party, for itself and the benefit of the Lenders, of a lien on and security interest in all of its right, title and interest in, to and under the following (herein referred to as "Intellectual Property Collateral"):

- all of its owned Trademarks and Trademark Licenses to which it is a party, including those referred to on Schedule I hereto; and
  - (i) all renewals, reissues, continuations or extensions of the foregoing;
- all goodwill of the business connected with the use of, and (ii) symbolized by, each Trademark and each Trademark License; and
- (iii) all Proceeds of the foregoing, including any claim by the Grantor against third parties for past, present, future (a) infringement or dilution of any Trademark or Trademark licensed under any Trademark License or (b) injury to the goodwill associated with any Trademark or any Trademark licensed under any Trademark License;
- all of its Copyrights and Copyright Licenses to which it is a party, including those referred to on Schedule II hereto; and
- all renewals, reissues, continuations or extensions of the foregoing; (i) and
- all Proceeds of the foregoing, including any claim by the Grantor (ii) against third parties for past, present, future infringement or dilution of any Copyright or Copyright licensed under any Copyright License; and
- all of its Patents and Patent Licenses to which it is a party, including those referred to on Schedule III hereto; and
- (i) all renewals, reissues, continuations or extensions of the foregoing; and
- (ii) all Proceeds of the foregoing, including any claim by the Grantor against third parties for past, present or future infringement or dilution of any Patent or any Patent licensed under any Patent License.
- Section 3. Acknowledgement. The security interests reaffirmed herein are granted in conjunction with the security interest granted to Secured Party, for itself and the benefit of the Lenders, pursuant to the Loan Agreement and the Grantor hereby acknowledges and affirms that the rights and remedies of Secured Party and Lenders with respect to the security interest in the Intellectual Property Collateral reaffirmed herein are more fully set forth in the Loan Agreement. the terms and provisions of which are incorporated by reference herein as if fully set forth herein. To the extent that there is any conflict or inconsistency between this Acknowledgement and the Loan Agreement, the terms and conditions of the Loan Agreement shall govern.

[Signatures appear on the following page]

IN WITNESS WHEREOF, the Grantor has caused this Acknowledgment of Intellectual Property Collateral Lien to be executed and delivered by its duly authorized offer as of the date first set forth above.

ELGAR ELECTRONICS CORPORATION

By: Name: John P. Mei

Title: Chief Financial Officer

Accepted and Agreed:

CAPITALSOURCE FINANCE LLC, as Secured Party

By:
Name:
Title:

Acknowledgement of Intellectual Property Collateral Lien

# ELGAR ELECTRONICS CORPORATION

s	TATE OF CALIFORNIA				
С	OUNTY OF San A	<u> </u>	2 <b>9</b> 0	) ss.	
1	n 3/1/04	, befo	ore me, 19	noverly	m. Overak notary Public
ρε	ersonally appeared 🔍	the	of Por	Name and Julie of	of Officer (e.g. "Jane Doe, Notary Public")
_	z O			of Signer(s)	,
<u>V</u> ∠	Commi	RLY M.	DVORAK 1321423	mame(s) is/are s me that he/sim capacity(ies), ar	pasis of satisfactory evidence to be the person(s) whose subscribed to the within instrument and acknowledged to be they executed the same in his/ber/tbeir authorized and that by his/ber/tbeir signature(s) on the instrument the ne entity upon behalf of which the person(s) acted, strument.
	San (	Diego	California &	WITNESS my h	and and official seal.
!	My Corran, I	Orpines	Sep 20, 2005	Kingbe	Signature of Notary Public
				OPTION	<b>A</b> L
Th pre	ough the data below is no event fraudulent reattachn	ot requ	uired by law, of this form.	it may prove valu	able to persons relying on the document and could
	CAPACITY(IES) CLAI			(8)	DESCRIPTION OF ATTACKED POSITION
	Individual		4.4.112.11	,	DESCRIPTION OF ATTACHED DOCUMENT
įΣ	Corporate Officer				Acknowledgement of Intellectual
	(FO				Proporty Lieu
	Tit	le(s)			Title or Type of Document
	Partner(s)		Limited General		
	Attorney-In-Fact Trustee(s)	_	Ochera		Number of Pages
	Guardian/Conservator Other:				
Sigi	ner is Representing:				Date of Document
Nar	ne of Person(s) or Entity(		1.3		
	iger Electronic	<u>&gt; C</u>	orborati	<u> </u>	None
		_		<del></del>	Signer(s) Other Than Named Above

IN WITNESS WHEREOF, the Grantor has caused this Acknowledgment of Intellectual Property Collateral Lien to be executed and delivered by its duly authorized offer as of the date first set forth above.

### **ELGAR ELECTRONICS CORPORATION**

ву:			
N. F	T 1	D 1 ( )	

Name: John P. Mei

Title: Chief Financial Officer

Accepted and Agreed:

CAPITALSOURCE FINANCE LLC, as Secured Party

3y: \_**//** 

Yame:

Joseph Turitz General Counsel

#### **SCHEDULE I**

to

## ACKNOWLEDGEMENT OF INTELLECTUAL PROPERTY COLLATERAL LIEN <u>TRADEMARK REGISTRATIONS</u>

#### A. REGISTERED TRADEMARKS

Grantor	Tondonosia	Registration		Registration No.
Grantor	<u>Trademarks</u>	<u>Date</u>	<u>Status</u>	(Serial No)
Elgar Electronics Corporation	"ELGAR"	11/11/03	Active	2,781,232
Elgar Electronics Corporation	"ELGAR"	3/19/02	Active	2,548,827
Elgar Electronics Corporation	"ELGAR" (Stylized)	12/23/03	Active	2,796,705
Elgar Electronics Corporation	"ELGAR" (Stylized)	3/19/02	Active	2,548,823
Elgar Electronics Corporation	"SMARTWAVE"	9/24/02	Active	2,624,856
Elgar Electronics Corporation	"SW"	3/19/02	Active	2,548,824
Elgar Electronics Corporation	"TW"	9/24/02	Active	2,624,857
Elgar Electronics Corporation	"GUPS"	3/26/02	Active	2,551,585
Elgar Electronics Corporation	"EW"	3/19/02	Active	2,548,822
Elgar Electronics Corporation	"CONTINUOUSWAVE"	7/16/02	Active	2,596,187
Elgar Electronics Corporation	"CW"	2/4/03	Active	2,684,819
Elgar Electronics Corporation	"SORENSEN"	11/13/73	Active	0,972,782
Elgar Electronics Corporation	"POWERTEN"	12/2/03	Active	2,788,297
Elgar Electronics Corporation	"POWERTEN" (Stylized)	5/6/03	Active	2,713,410
Elgar Electronics Corporation	"POWER TEN INC." (and design)	11/17/98	Active	2,203,753

#### B. TRADEMARK APPLICATIONS

None.

### C. TRADEMARK LICENSES

Including Name of Agreement, Parties and Date of Agreement

None.

Acknowledgement of Intellectual Property Collateral Lien

#### **SCHEDULE II**

to

# ACKNOWLEDGEMENT OF INTELLECTUAL PROPERTY COLLATERAL LIEN COPYRIGHT REGISTRATIONS

A. REGISTERED COPYRIGHTS
Including Copyright Reg. No. and Date

None.

B. COPYRIGHT APPLICATIONS

None.

C. COPYRIGHT LICENSES

Including Name of Agreement, Parties and Date of Agreement

None.

#### SCHEDULE III

to

# ACKNOWLEDGEMENT OF INTELLECTUAL PROPERTY COLLATERAL LIEN PATENT REGISTRATIONS

#### A. REGISTERED PATENTS

<u>Grantor</u>	Patents	<u>Issued</u> <u>Date</u>	Status	Patent No.
Elgar Electronics Corporation	"Overvoltage Protection Circuit"	5/29/01	Active	6,239,961
Elgar Electronics Corporation (formerly owned by Power Ten, Inc.)	"Internally Programmable Modular Power Supply and Method"	6/29/99	Active	5,917,719

### B. PATENT APPLICATIONS

None.

C. PATENT LICENSES

Including Name of Agreement, Parties and Date of Agreement

None.

Acknowledgement of Intellectual Property Collateral Lien

**RECORDED: 04/09/2004**